

#### M1 THRU M7

Reverse Voltage - 50 to 1000 Volts Forward Current - 1.0 Ampere

#### SURFACE MOUNT GENERAL RECTIFIER

#### **Features**

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ Idea for printed circuit board
- Glass passivated Junction chip
- ◆ Low reverse leakage
- High forward surge current capability
- High temperature soldering guaranteed
  250 C/10 seconds at terminals

# **Mechanical Data**

Case: JEDEC DO-214AC/SMA Molded plastic body

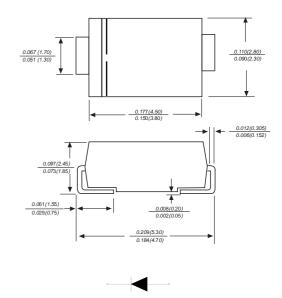
Terminals: Solder plated, solderable per MIL-STD-750, Method 2026

Polarity: Polarity symbol marking on body

Mounting Position: Any

Weight: 0.0019ounce, 0.055 grams

# DO-214AC/SMA ROHS



Dimensions in inches and (millimeters)

# **Maximum Ratings And Electrical Characteristics**

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter		MDD	MDD	MDD	MDD	MDD	MDD	MDD	
Marking Code		M1	M2	М3	M4	M5	M6	M7	UNITS
Maximum repetitive peak reverse voltage	Vrrm	50	100	200	400	600	800	1000	V
Maximum RMS voltage		35	70	140	280	420	560	700	V
Maximum DC blocking voltage	VDC	50	100	200	400	600	800	1000	V
Maximum average forward rectified current	I(AV)				1				А
Peak forward surge current 8.3ms single half sine-wave superimposed onrated load		30					А		
Maximum instantaneous forward voltage at 1.0A		1.1					V		
Maximum DC reverse current TA=25℃ at rated DC blocking voltage TA=125℃	lR				5 50				uA
Typical junction capacitance (NOTE 1)	Cı				15				pF
Typical thermal resistance (NOTE 2)		75					°C/W		
Operating junction and storage temperature range		-55 to +150					$^{\circ}$ C		

Note:1.Measured at 1MHz and applied reverse voltage of 4.0V D.C. 2.P.C.B. mounted with 2.0x2.0"(2.54x2.54cm) copper pad areas

http://www.microdiode.com Rev:2024A4 Page :1





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## **Ratings And Characteristic Curves**

Fig.1 Forward Current Derating Curve

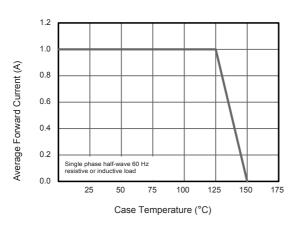


Fig.2 Typical Instaneous Reverse Characteristics

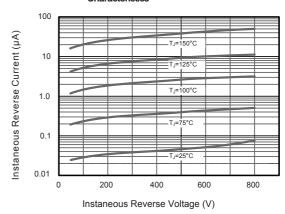


Fig.3 Typical Forward Characteristic

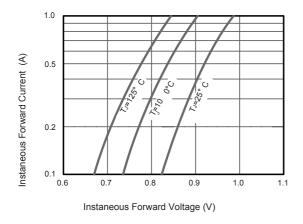


Fig.4 Typical Junction Capacitance

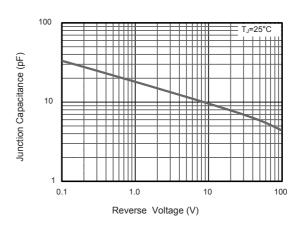


Fig.5 Maximum Non-Repetitive Peak Forward Surage Current

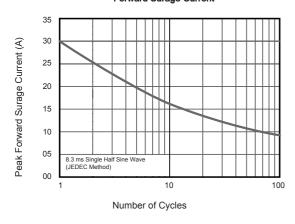
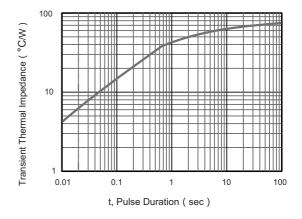


Fig.6- Typical Transient Thermal Impedance



The curve above is for reference only.

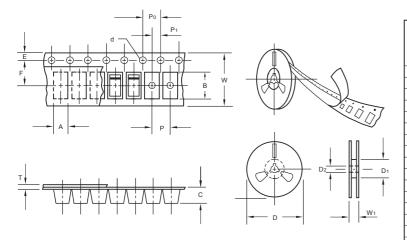
http://www.microdiode.com Rev:2024A4 Page :2



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# **Packing information**



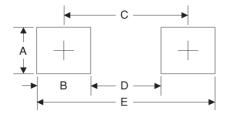
			unit:mm
Item	Symbol	Tolerance	SMA
Carrier width	А	0.1	2.80
Carrier length	В	0.1	5.33
Carrier depth	С	0.1	2.36
Sprocket hole	d	0.05	1.50
13" Reel outside diameter	D	2.0	330.00
13" Reel inner diameter	D1	min	50.00
7" Reel outside diameter	D	2.0	178.00
7" Reel inner diameter	D1	min	62.00
Feed hole diameter	D2	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	5.50
Punch hole pitch	Р	0.1	4.00
Sprocket hole pitch	P <sub>0</sub>	0.1	4.00
Embossment center	P1	0.1	2.00
Overall tape thickness	T	0.1	0.28
Tape width	W	0.3	12.00
Reel width	W1	1.0	18.00

Note: Devices are packed in accordance with EIA standar RS-481-A and specifications listed above.

## Reel packing

PACKAGE	REEL SIZE	REEL (pcs)	COMPONENT SPACING (m/m)	BOX (pcs)	INNER BOX (m/m)	REEL DIA, (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
SMA	7"	2,000	4.0	4,000	183*155*183	178	382*356*392	80,000	16.0
SMA	11"	5,000	4.0	10,000	290*290*38	330	310*310*360	80,000	11.0
SMA	13"	7,500	4.0	15,000	335*335*38	330	350*330*360	120,000	14.5

# **Suggested Pad Layout**



Symbol	Unit (mm)	Unit (inch)
Α	1.68	0.066
В	1.52	0.060
С	3.93	0.154
D	2.41	0.095
Е	5.45	0.215

http://www.microdiode.com Rev:2024A4 Page :3